

P-Channel 100 V (D-S) MOSFET

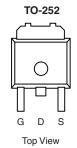
PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)	
- 100	0.100 at V _{GS} = - 10 V	- 16	11.7	
- 100	0.120 at V_{GS} = - 4.5 V	- 15	11.7	

FEATURES

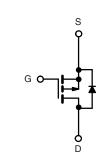
- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Power Switch
- DC/DC Converters



Drain Connected to Tab



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_{\rm C} = 25 ^{\circ}{\rm C}$, unless oth	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 100	v		
Gate-Source Voltage	V _{GS}	± 20	v		
Continuous Drain Current (T_{1} = 150 °C)	T _C = 25 °C		- 16		
Continuous Drain Current $(T_j = 150 \text{ C})$	T _C = 70 °C	I _D	- 14	•	
Pulsed Drain Current	I _{DM}	- 50	- A		
Avalanche Current	I _{AS}	- 18			
Single Avalanche Energy ^a L = 0.1 mH		E _{AS}	16.2	mJ	
	T _C = 25 °C	P	32.1 ^b	14/	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	– P _D –	2.5	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W	
Junction-to-Case (Drain)	R _{thJC}	3.9	0/11	

Notes:

a. Duty cycle ≤ 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).



COMPLIANT HALOGEN

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 V, I_{D} = -250 \mu A$	- 100			v
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 2.5	v
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA
		$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	μΑ
		V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 150 °C			- 250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 15			А
	B	V _{GS} = - 10 V, I _D = - 3.6 A		0.100		Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 3.4 A		0.120		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 3.6 A		12		S
Dynamic ^b						
Input Capacitance	C _{iss}			1055		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 50 V, f = 1 MHz		65		
Reverse Transfer Capacitance	C _{rss}			41		
Tatal Cata Charge ⁶	Qg	$V_{DS} = -50 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.6 \text{ A}$		23.2	34.8	nC
Total Gate Charge ^c	Qg			11.7	17.6	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = - 50 V, V_{GS} = - 4.5 V, I_{D} = - 3.6 A		3.5		
Gate-Drain Charge ^c	Q _{gd}			4.8		
Gate Resistance	Rg	f = 1 MHz	1.2	5.7	11.5	Ω
Turn-On Delay Time ^c	t _{d(on)}			7	14	
Rise Time ^c	t _r	V_{DD} = - 50 V, R_L = 17.2 Ω		12	18	ns
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 2.9 A, V_{GEN} = - 10 V, R_g = 1 Ω		33	50	115
Fall Time ^c	t _f			9	18	
Drain-Source Body Diode Ratings and	nd Character	istics T _C = 25 °C ^b				
Continuous Current	ا _S				- 8.8	
Pulsed Current	I _{SM}				- 15	A
Forward Voltage ^a	V _{SD}	I _F = - 2.9 A, V _{GS} = 0 V		- 0.8	- 1.5	V
Reverse Recovery Time	t _{rr}			50	75	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	Α
Reverse Recovery Charge	Q _{rr}	1 F		98	147	nC

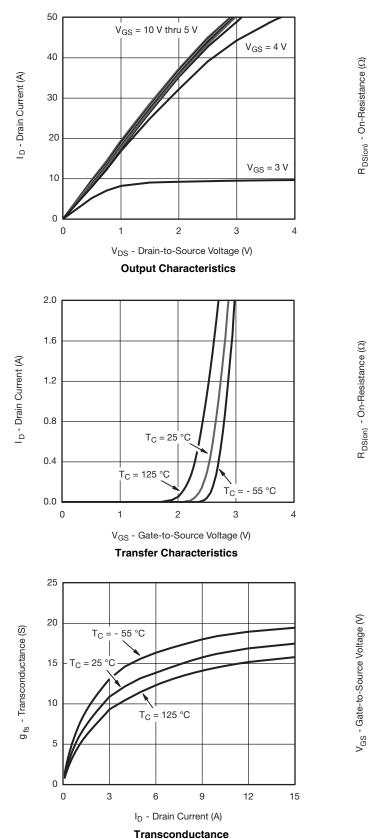
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

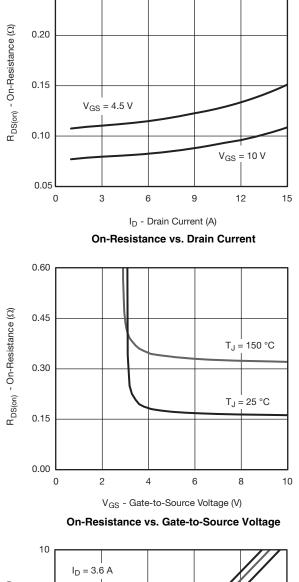
b. Guaranteed by design, not subject to production testing.c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

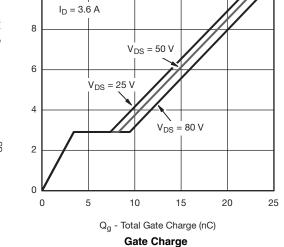




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

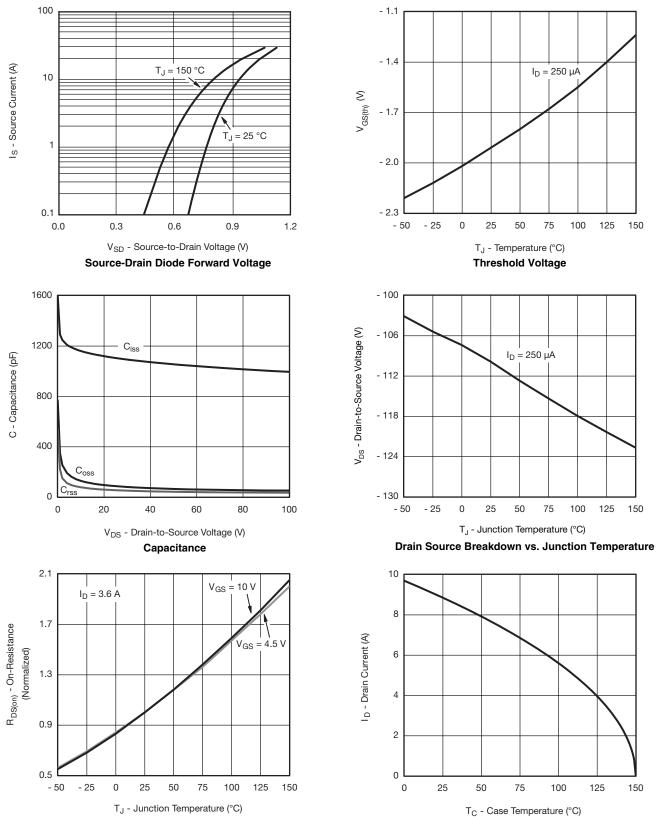


0.25

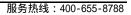




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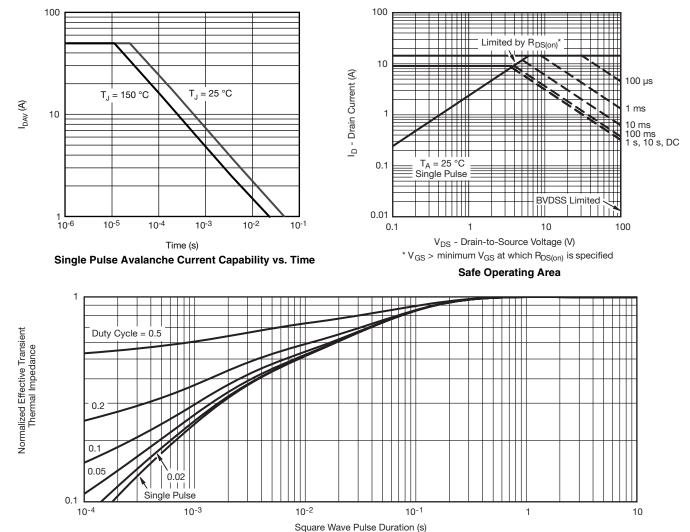
On-Resistance vs. Junction Temperature



Current Derating

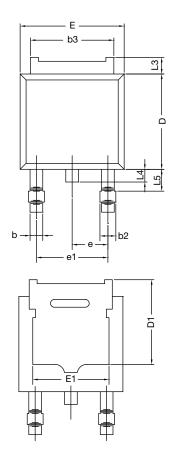


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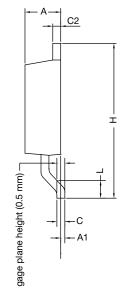


Normalized Thermal Transient Impedance, Junction-to-Case





TO-252AA Case Outline



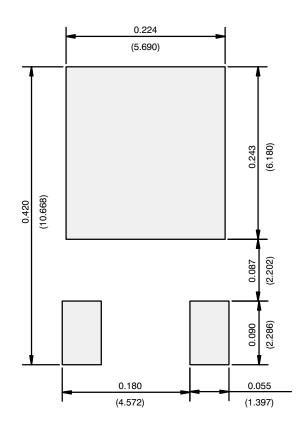
	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	28 BSC		0.090 BSC	
e1	4.56 BSC		0.180	BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	

Notes

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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